



# MJ N-Channel Enhancement Mode Power MOSFET

## Description

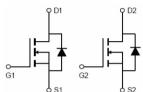
The MJ60ND18G uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

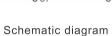
#### General Features

- ♦  $V_{DS}=60V,I_{D}=18A$   $R_{DS(ON)}<35m\Omega$  @  $V_{GS}=10V$  $R_{DS(ON)}<40m\Omega$  @  $V_{GS}=4.5V$
- ♦ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E AS
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability

## Application

- ◆ Power switching application
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply







Top View

### 100% UIS TESTED! 100% ΔVds TESTED!

# Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ60ND18G	MJ60ND18G	DFN 5X6 -8L	-	-	-

### Absolute Maximum Ratings (Tc = 25 °Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	18	Α
Drain Current-Continuous(Tc =100℃)	ID(100°C)	12.7	А
Pulsed Drain Current	Ірм	60	А
Maximum Power Dissipation	Po	45	W
Derating factor		0.3	W/°C
Single pulse avalanche energy (Note 5)	Eas	72	mJ
Operating Junction and Storage Temperature Range	ТJ ,Tsтg	-55 To 175	°C

#### Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	3.3	°C/W	
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# Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVpss	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60	-	-	V
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	1.2	1.6	2.5	V
	_	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	_	24	35	mΩ
Drain-Source On-State Resistance	Rds(on)	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	-	30	40	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =10A	11	-	-	S
Dynamic Characteristics (Note 4)					I	
Input Capacitance	Clss		_	973	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V, F=1.0MHz	_	61.2	-	PF
Reverse Transfer Capacitance	Crss	_	_	58.8	_	PF
Switching Characteristics (Note 4)					1	
Turn-on Delay Time	t <sub>d(on)</sub>		-	5	-	nS
Turn-on Rise Time	tr	VDD=30V,RL=6.7Ω	-	2.6	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =10V,R <sub>G</sub> =3Ω	-	16.1	-	nS
Turn-Off Fall Time	tf	-	-	2.3	-	nS
Total Gate Charge	Qg		-	25	-	nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =30V,I <sub>D</sub> =10A, V <sub>GS</sub> =10V	_	4.5	-	nC
Gate-Drain Charge	Qgd	-	-	6.5	-	nC
Drain-Source Diode Characteristics	I		1		I	1
Diode Forward Voltage (Note 3)	VsD	V <sub>GS</sub> =0V,I <sub>S</sub> =10A	_	_	1.2	V
Diode Forward Current (Note 2)	Is		-	-	18	А
Reverse Recovery Time	trr	TJ=25°C, IF=10A	-	29	_	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	49	_	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is n	egligible(tu	ırn-on is d	ominated b	L y LS+LΓ

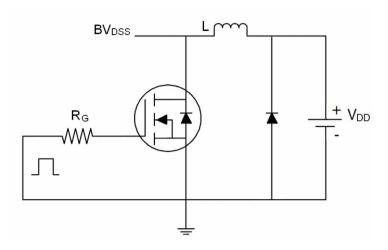
#### Notes:

- $\textcircled{1} \ \mathsf{Repetitive} \ \mathsf{Rating:} \ \mathsf{Pulse} \ \mathsf{width} \ \mathsf{limited} \ \mathsf{by} \ \mathsf{maximum} \ \mathsf{junction} \ \mathsf{temperature}.$
- ② Surface Mounted on FR4 Board, t≤10sec.
- ③ Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%.
- $\ensuremath{\mathfrak{A}}$  Guaranteed by design, not subject to production

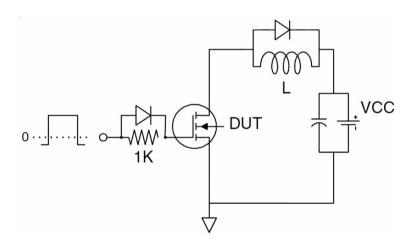




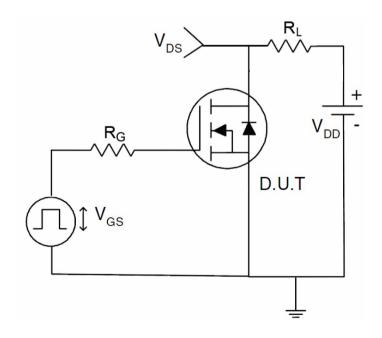
## Test circuit



Eas test Circuit



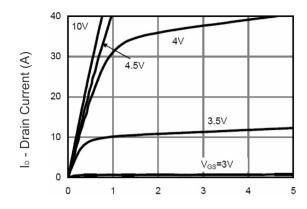
Gate charge test Circuit



Switch Time Test Circuit

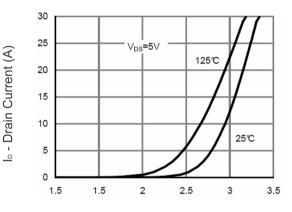


# Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

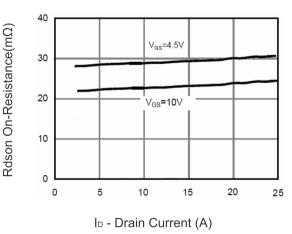
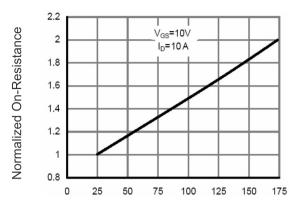


Figure 3 Rdson- Drain Current



 $T_{\text{J}}$  -Junction Temperature(°C)

Figure 4 Rdson-JunctionTemperature

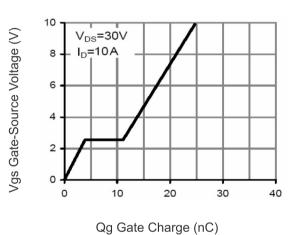
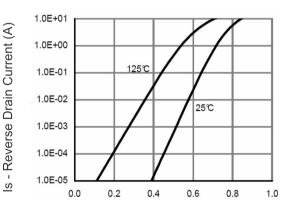


Figure 5 Gate Charge

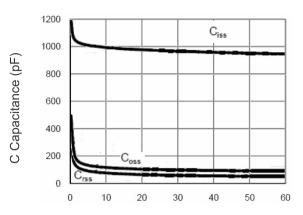


Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

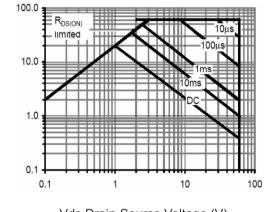


lo - Drain Current (A)



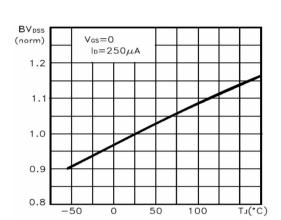
Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



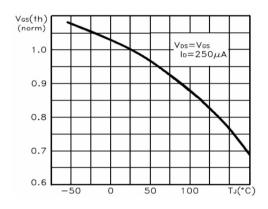
Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



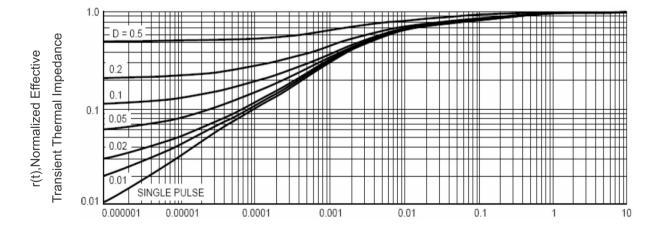
T<sub>J</sub> -Junction Temperature(°C)

Figure 9 BVDSS vs Junction Temperature



T<sub>J</sub> -Junction Temperature(°C)

Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



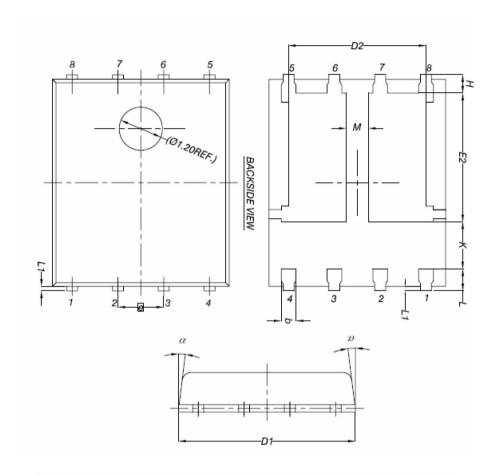
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

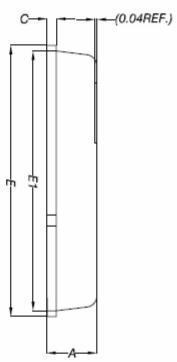




# DFN5X6-8L Package Information



544	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
М	0.50	-	-	
α	0°	-	12°	







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